

High Performance LVPECL Oscillator with Frequency Margining – Pin Control

Features

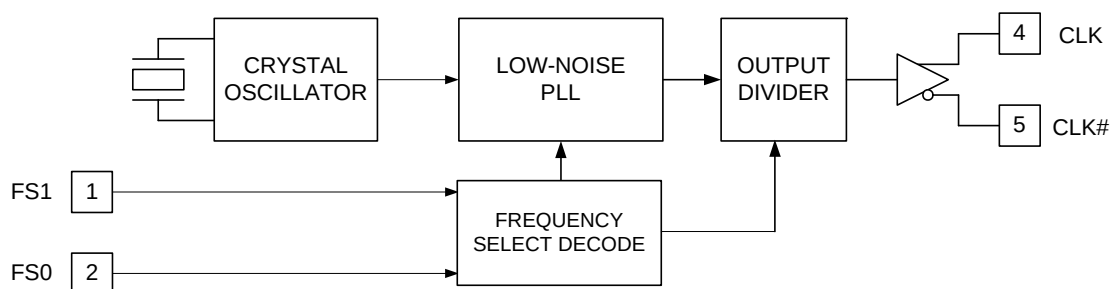
- Low Jitter Crystal Oscillator (XO)
- Less than 1 ps Typical RMS Phase Jitter
- Differential LVPECL Output
- Output Frequency from 50 MHz to 690 MHz
- Two Frequency Margining Control Pins (FS0, FS1)
- Factory Configured or Field Programmable
- Integrated Phase-Locked Loop (PLL)
- Supply Voltage: 3.3 V or 2.5 V
- Pb-Free Package: 5.0 × 3.2 mm LCC
- Commercial and Industrial Temperature Ranges

Functional Description

The CY2XF34 is a high performance and high frequency Crystal Oscillator (XO). It uses a Cypress proprietary low noise PLL to synthesize the frequency from an integrated crystal. The output frequency can be changed through two select pins, allowing easy frequency margin testing in applications.

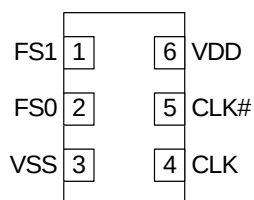
The CY2XF34 is available as a factory configured device or as a field programmable device.

Logic Block Diagram



Pinouts

Figure 1. Pin Diagram - 6-pin Ceramic LCC



Pin Definitions

Pin	Name	I/O Type	Description
1, 2	FS1, FS0	CMOS input	Frequency select
4, 5	CLK, CLK#	LVPECL output	Differential output clock
6	VDD	Power	Supply voltage: 2.5 V or 3.3 V
3	VSS	Power	Ground

Contents

Logic Block Diagram	1	Switching Waveforms	7
Pinouts	1	Termination Circuits	7
Pin Definitions	1	Ordering Information	8
Functional Description	3	Possible Configuration	8
Programming Description	3	Ordering Code Definitions	8
Field Programmable CY2XF34F	3	Package Drawings and Dimensions	9
Factory Configured CY2XF34	3	Acronyms	10
Programming Variables	3	Document Conventions	10
Output Frequencies	3	Units of Measure	10
Industrial Versus Commercial Device Performance	3	Document History Page	11
Phase Noise Versus Jitter Performance	3	Sales, Solutions, and Legal Information	12
Absolute Maximum Conditions	4	Worldwide Sales and Design Support	12
Operating Conditions	4	Products	12
DC Electrical Characteristics	4	PSoC Solutions	12
AC Electrical Characteristics	5		
Typical Output Characteristics	5		

Functional Description

The FS0 and FS1 pins select between four different output frequencies, as shown in [Table 1](#). Frequency margining is a common application for this feature. One frequency is used for the standard operating mode of the device, while the other frequencies are available for margin testing, either during product development or in system manufacturing test.

Table 1. Frequency Select

FS1	FS0	Output Frequency
0	0	Frequency 0
0	1	Frequency 1
1	0	Frequency 2
1	1	Frequency 3

When changing the output frequency, the frequency transition is not guaranteed to be smooth. There can be frequency excursions beyond the start frequency and the new frequency. Glitches and runt pulses are possible, and time must be allowed for the PLL to relock.

Programming Description

The CY2XF34 is a programmable device. Before being used in an application, it must be programmed with the output frequencies and other variables described in a later section. Two different device types are available, each with its own programming flow. They are described in the following sections.

Field Programmable CY2XF34F

Field programmable devices are shipped unprogrammed and must be programmed before being installed on a printed circuit board (PCB). Customers use CyberClocks™ Online Software to specify the device configuration and generate a JEDEC (extension .jed) programming file. Programming of samples and prototype quantities is available using a Cypress programmer. Third party vendors manufacture programmers for small to large volume applications. Cypress's value added distribution partners also provide programming services. Field programmable devices are designated with an "F" in the part number. They are intended for quick prototyping and inventory reduction. The CY2XF34 is One Time Programmable (OTP).

The software is located at [CyberClocks\(TM\) Online Software](#)

Factory Configured CY2XF34

For customers wanting ready-to-use devices, the CY2XF34 is available with no field programming required. All requests are submitted to the local Cypress Field Application Engineer (FAE) or sales representative. After the request is processed, you receive a new part number, samples, and datasheet with the programmed values. This part number is used for additional sample requests and production orders.

Programming Variables

Output Frequencies

The CY2XF34 is programmed with up to four independent output frequencies, which are then selected using the FS0 and FS1 pins. The device can synthesize frequencies to a resolution of 1 part per million (ppm), but the actual accuracy of the output frequency is limited by the accuracy of the integrated reference crystal.

The CY2XF34 has an output frequency range of 50 MHz to 690 MHz, but the range is not continuous. The CY2XF34 cannot generate frequencies in the ranges of 521 MHz to 529 MHz, and 596 MHz to 617 MHz.

Industrial Versus Commercial Device Performance

Industrial and Commercial devices have different internal crystals. This has a potentially significant impact on performance levels for applications requiring the lowest possible phase noise. CyberClocks Online Software displays expected performance for both options.

Phase Noise Versus Jitter Performance

In most cases, the device configuration for optimal phase noise performance is different from the device configuration for optimal cycle to cycle or period jitter. CyberClocks Online Software includes algorithms to optimize performance for either parameter.

Table 2. Device Programming Variables

Variable
Output Frequency 0 (Power on default)
Output Frequency 1
Output Frequency 2
Output Frequency 3
Optimization (phase noise or jitter)
Temperature range (Commercial or Industrial)

Absolute Maximum Conditions

Parameter	Description	Condition	Min	Max	Unit
V_{DD}	Supply voltage		-0.5	4.4	V
$V_{IN}^{[1]}$	Input voltage, DC	Relative to V_{SS}	-0.5	$V_{DD} + 0.5$	V
T_S	Temperature, storage	Non operating	-55	135	°C
T_J	Temperature, Junction		-40	135	°C
ESD_{HBM}	ESD Protection (Human Body Model)	JEDEC STD 22-A114-B	2000	–	V
$\Theta_{JA}^{[2]}$	Thermal resistance, Junction to Ambient	0 m/s airflow		64	°C/W

Operating Conditions

Parameter	Description	Min	Typ	Max	Unit
V_{DD}	3.3 V Supply voltage range	3.135	3.3	3.465	V
	2.5 V Supply voltage range	2.375	2.5	2.625	V
T_{PU}	Power Up Time for V_{DD} to Reach Minimum Specified Voltage (Power Ramp is Monotonic)	0.05	–	500	ms
T_A	Ambient temperature (Commercial)	0	–	70	°C
	Ambient temperature (Industrial)	-40	–	85	°C

DC Electrical Characteristics

Parameter	Description	Condition	Min	Typ	Max	Unit
$I_{DD}^{[3]}$	Operating supply current	$V_{DD} = 3.465$ V, CLK = 150 MHz, output terminated	–	–	150	mA
		$V_{DD} = 2.625$ V, CLK = 150 MHz, output terminated	–	–	145	mA
V_{OH}	LVPECL high output voltage	$V_{DD} = 3.3$ V or 2.5 V, $R_{TERM} = 50 \Omega$ to $V_{DD} - 2.0$ V	$V_{DD} - 1.15$	–	$V_{DD} - 0.75$	V
V_{OL}	LVPECL low output voltage	$V_{DD} = 3.3$ V or 2.5 V, $R_{TERM} = 50 \Omega$ to $V_{DD} - 2.0$ V	$V_{DD} - 2.0$	–	$V_{DD} - 1.625$	V
V_{OD1}	LVPECL output voltage swing ($V_{OH} - V_{OL}$)	$V_{DD} = 3.3$ V or 2.5 V, $R_{TERM} = 50 \Omega$ to $V_{DD} - 2.0$ V	600	–	1000	mV
V_{OD2}	LVPECL output voltage swing ($V_{OH} - V_{OL}$)	$V_{DD} = 2.5$ V, $R_{TERM} = 50 \Omega$ to $V_{DD} - 1.5$ V	500	–	1000	mV
V_{OCM}	LVPECL output common mode Voltage ($(V_{OH} + V_{OL})/2$)	$V_{DD} = 2.5$ V, $R_{TERM} = 50 \Omega$ to $V_{DD} - 1.5$ V	1.2	–	–	V
V_{IH}	Input high voltage		$0.7 \times V_{DD}$	–	–	V
V_{IL}	Input low voltage		–	–	$0.3 \times V_{DD}$	V
I_{IH0}	Input high current, FS0 pin	Input = V_{DD}	–	–	115	μA
I_{IH1}	Input high current, FS1 pin	Input = V_{DD}	–	–	10	μA
I_{IL0}	Input low current, FS0 pin	Input = V_{SS}	-50	–	–	μA
I_{IL1}	Input low current, FS1 pin	Input = V_{SS}	-20	–	–	μA

Notes

1. The voltage on any input or IO pin cannot exceed the power pin during power up.
2. Simulated. The board is derived from the JEDEC multilayer standard. It measures 76 × 114 × 1.6 mm and has 4-layers of copper (2/1/1/2 oz.). The internal layers are 100% copper planes, while the top and bottom layers have 50% metalization. No vias are included in the model.
3. I_{DD} includes ~24 mA of current that is dissipated externally in the output termination resistors.

DC Electrical Characteristics (continued)

Parameter	Description	Condition	Min	Typ	Max	Unit
$C_{IN0}^{[4]}$	Input Capacitance, FS0 pin		–	15	–	pF
$C_{IN1}^{[4]}$	Input Capacitance, FS1 pin		–	4	–	pF

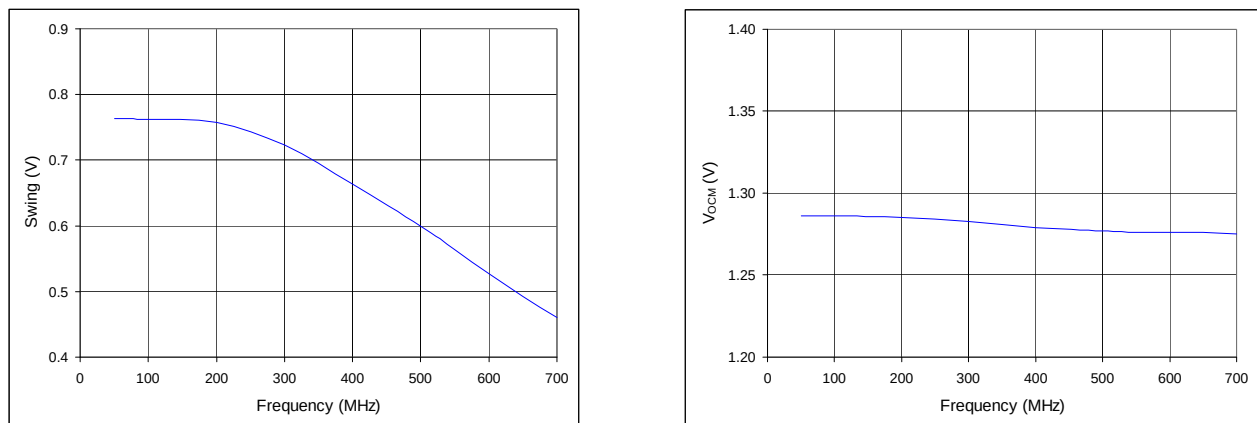
AC Electrical Characteristics

The AC Electrical Characteristics for part CY2XF34 are as follows ^[4]

Parameter	Description	Condition	Min	Typ	Max	Unit
F_{OUT}	Output Frequency ^[5]		50	–	690	MHz
FSC	Frequency Stability, commercial devices ^[6]	$T_A = 0\text{ }^{\circ}\text{C to } 70\text{ }^{\circ}\text{C}$	–	–	± 35	ppm
FSI	Frequency Stability, industrial devices ^[6]	$T_A = -40\text{ }^{\circ}\text{C to } 85\text{ }^{\circ}\text{C}$	–	–	± 55	ppm
AG	Aging, 10 years		–	–	± 15	ppm
T_{DC}	Output Duty Cycle	$F \leq 450\text{ MHz}$, measured at zero crossing	45	50	55	%
		$F > 450\text{ MHz}$, measured at zero crossing	40	50	60	%
T_R, T_F	Output Rise and Fall Time	20% and 80% of full output swing	0.2	0.4	1.0	ns
T_{LOCK}	Startup Time	Time for CLK to reach valid frequency measured from the time $V_{DD} = V_{DD(min)}$	–	–	10	ms
T_{LFS}	Re-lock Time	Time for CLK to reach valid frequency from FS0 or FS1 pin change	–	–	10	ms
$T_{Jitter(\phi)}$	RMS Phase Jitter (Random)	$f_{OUT} = 106.25\text{ MHz}$ (12 kHz–20 MHz)	–	1	–	ps

Typical Output Characteristics

Figure 2. 2.5V Supply and Termination to V_{DD} –1.5 V, minimum V_{DD} and maximum T_A



Notes

- Not 100% tested, guaranteed by design and characterization.
- This parameter is specified in CyberClocks Online software.
- Frequency stability is the maximum variation in frequency from F_0 . It includes initial accuracy, plus variation from temperature and supply voltage.

Figure 3. 2.5 V Supply and Termination to $V_{DD}-2$ V, minimum V_{DD} and maximum T_A

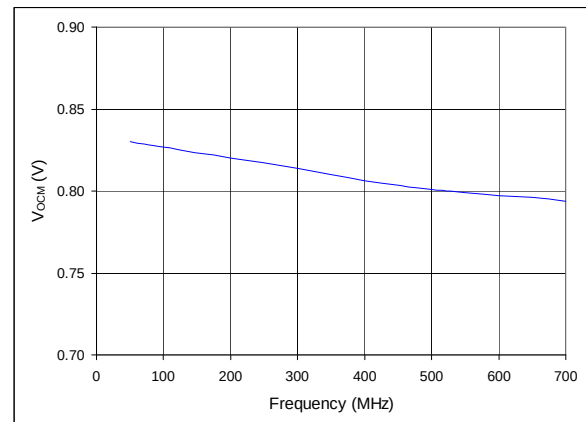
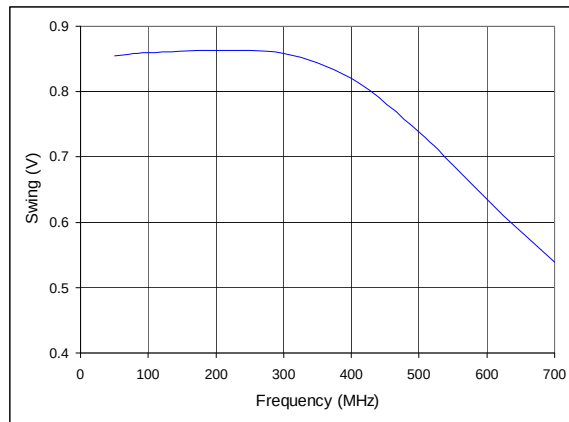
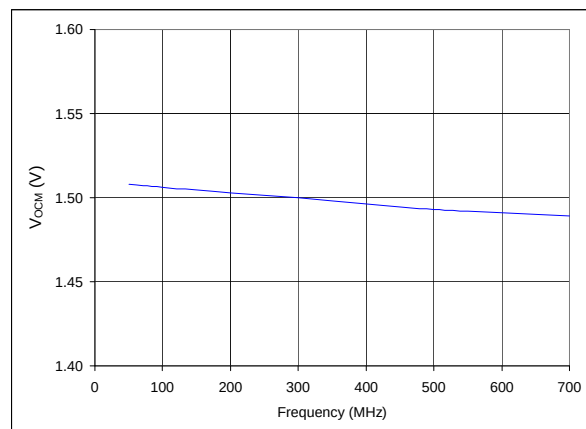
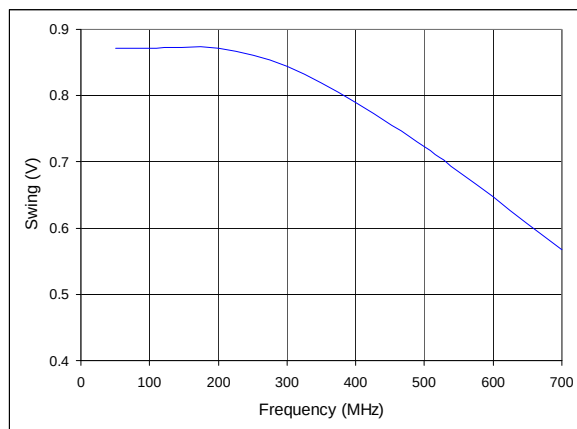


Figure 4. 3.3 V Supply and Termination to $V_{DD}-2$ V, minimum V_{DD} and maximum T_A



Switching Waveforms

Figure 5. Output DC Parameters

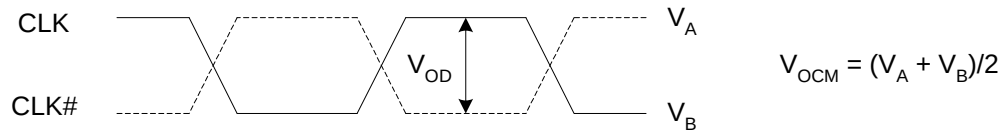


Figure 6. Duty Cycle Timing

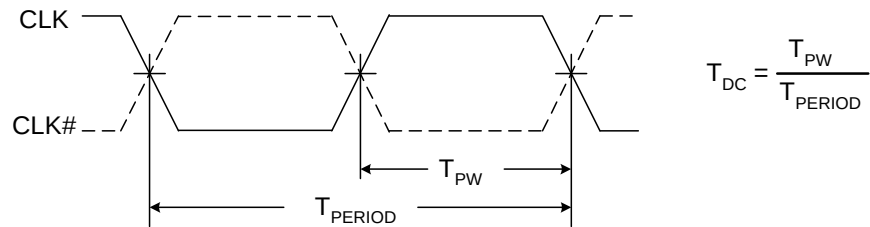
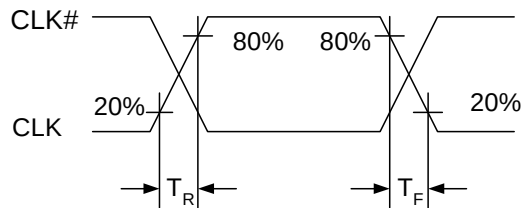
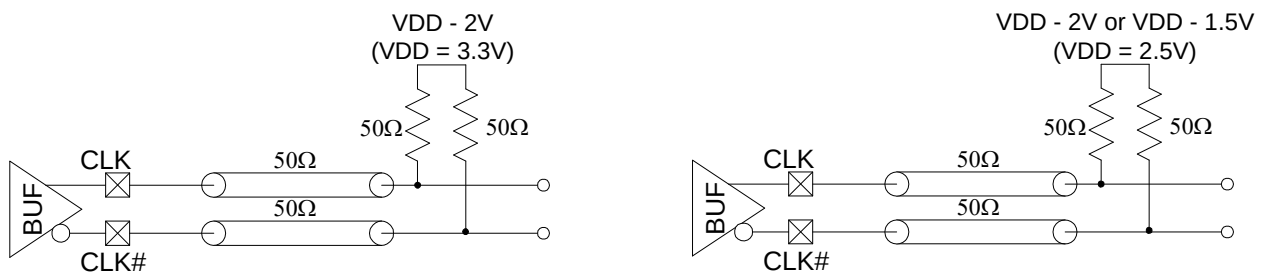


Figure 7. Output Rise and Fall Time



Termination Circuits

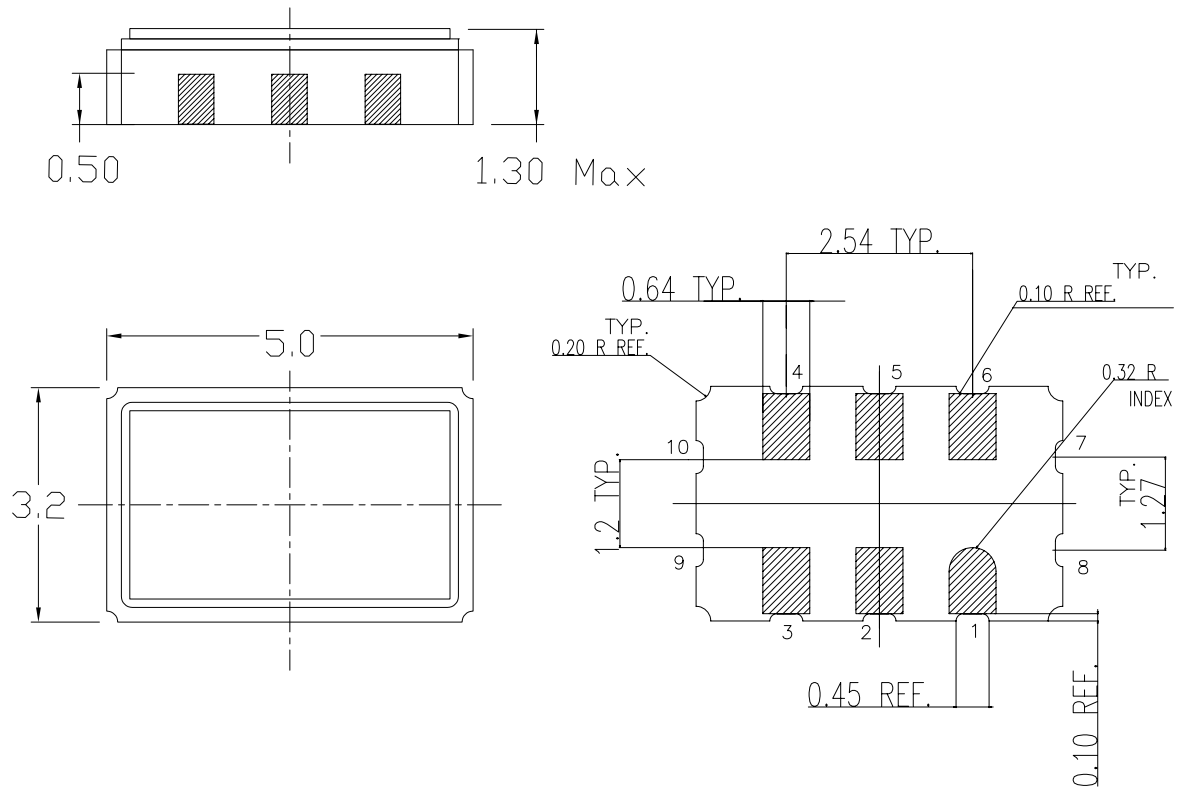
Figure 8. LVPECL Termination





Package Drawings and Dimensions

Figure 9. 6-pin 3.2 × 5.0 mm Ceramic LCC LZ06A



Dimensions in mm
 General Tolerance: $\pm 0.15\text{MM}$
 Kyocera dwg ref KD-VA6432-A
 Package Weight ~ 0.12 grams

001-10044 *A

Acronyms

Acronym	Description
CMOS	complementary metal oxide semiconductor
ESD	electrostatic discharge
FAE	field application engineer
I/O	input/output
OTP	one time programmable
PCB	printed circuit board
PLL	phase-locked loop
SMD	surface mounted devices

Document Conventions

Units of Measure

Symbol	Unit of Measure
°C	degree celsius
μA	microampere
mA	milliampere
mm	millimeter
ms	millisecond
mV	millivolt
MHz	megahertz
ns	nanosecond
pF	picofarad
ps	picosecond
ppm	parts per million
V	volts
W	watts
%	percent
Ω	ohms

Document History Page

Document Title: CY2XF34 High Performance LVPECL Oscillator with Frequency Margining – Pin Control Document Number: 001-53149				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	2704379	KVM/PYRS	05/11/09	New datasheet
*A	2734005	WWZ	07/09/09	Post to external web
*B	2761926	KVM	09/10/09	Revised maximum output rise and fall times Added Absolute Maximum Conditions table
*C	2898472	KVM	03/24/2010	Moved 'xxx' parts to Possible Configurations table. Updated package diagram.
*D	3199911	BASH	03/18/2011	Changed status from Preliminary to Final. Added Ordering Code Definitions . Added Acronyms and Units of Measure . Updated in new template.
*E	3281222	BASH	06/13/2011	Swapped FS0 and FS1 in Logic Block Diagram, Pinouts and Pin Definition on page 1.

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